## **Power Systems**

System processor modules for the 9009-41A, 9009-41G, 9009-42A, 9009-42G, 9223-42H, or 9223-42S



# Note Before using this information and the product it supports, read the information in "Safety notices" on page v, "Notices" on page 45, the IBM Systems Safety Notices manual, G229-9054, and the IBM Environmental Notices and User Guide, Z125–5823.

This edition applies to IBM® Power Systems servers that contain the POWER9™ processor and to all associated models.

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### **Safety notices**

Safety notices may be printed throughout this guide:

- DANGER notices call attention to a situation that is potentially lethal or extremely hazardous to people.
- **CAUTION** notices call attention to a situation that is potentially hazardous to people because of some existing condition.
- Attention notices call attention to the possibility of damage to a program, device, system, or data.

#### **World Trade safety information**

Several countries require the safety information contained in product publications to be presented in their national languages. If this requirement applies to your country, safety information documentation is included in the publications package (such as in printed documentation, on DVD, or as part of the product) shipped with the product. The documentation contains the safety information in your national language with references to the U.S. English source. Before using a U.S. English publication to install, operate, or service this product, you must first become familiar with the related safety information documentation. You should also refer to the safety information documentation any time you do not clearly understand any safety information in the U.S. English publications.

Replacement or additional copies of safety information documentation can be obtained by calling the IBM Hotline at 1-800-300-8751.

#### **German safety information**

Das Produkt ist nicht für den Einsatz an Bildschirmarbeitsplätzen im Sinne § 2 der Bildschirmarbeitsverordnung geeignet.

#### **Laser safety information**

IBM servers can use I/O cards or features that are fiber-optic based and that utilize lasers or LEDs.

#### Laser compliance

IBM servers may be installed inside or outside of an IT equipment rack.



**DANGER:** When working on or around the system, observe the following precautions:

Electrical voltage and current from power, telephone, and communication cables are hazardous. To avoid a shock hazard:

- If IBM supplied the power cord(s), connect power to this unit only with the IBM provided power cord. Do not use the IBM provided power cord for any other product.
- Do not open or service any power supply assembly.
- Do not connect or disconnect any cables or perform installation, maintenance, or reconfiguration of this product during an electrical storm.
- The product might be equipped with multiple power cords. To remove all hazardous voltages, disconnect all power cords.
  - For AC power, disconnect all power cords from their AC power source.
  - For racks with a DC power distribution panel (PDP), disconnect the customer's DC power source to the PDP.
- When connecting power to the product ensure all power cables are properly connected.
  - For racks with AC power, connect all power cords to a properly wired and grounded electrical outlet. Ensure that the outlet supplies proper voltage and phase rotation according to the system rating plate.

- For racks with a DC power distribution panel (PDP), connect the customer's DC power source to the PDP. Ensure that the proper polarity is used when attaching the DC power and DC power return wiring.
- Connect any equipment that will be attached to this product to properly wired outlets.
- When possible, use one hand only to connect or disconnect signal cables.
- Never turn on any equipment when there is evidence of fire, water, or structural damage.
- Do not attempt to switch on power to the machine until all possible unsafe conditions are corrected.
- Assume that an electrical safety hazard is present. Perform all continuity, grounding, and power checks specified during the subsystem installation procedures to ensure that the machine meets safety requirements.
- Do not continue with the inspection if any unsafe conditions are present.
- Before you open the device covers, unless instructed otherwise in the installation and configuration procedures: Disconnect the attached AC power cords, turn off the applicable circuit breakers located in the rack power distribution panel (PDP), and disconnect any telecommunications systems, networks, and modems.



#### **DANGER:**

• Connect and disconnect cables as described in the following procedures when installing, moving, or opening covers on this product or attached devices.

#### To Disconnect:

- 1. Turn off everything (unless instructed otherwise).
- 2. For AC power, remove the power cords from the outlets.
- 3. For racks with a DC power distribution panel (PDP), turn off the circuit breakers located in the PDP and remove the power from the Customer's DC power source.
- 4. Remove the signal cables from the connectors.
- 5. Remove all cables from the devices.

#### To Connect:

- 1. Turn off everything (unless instructed otherwise).
- 2. Attach all cables to the devices.
- 3. Attach the signal cables to the connectors.
- 4. For AC power, attach the power cords to the outlets.
- 5. For racks with a DC power distribution panel (PDP), restore the power from the Customer's DC power source and turn on the circuit breakers located in the PDP.
- 6. Turn on the devices.

Sharp edges, corners and joints may be present in and around the system. Use care when handling equipment to avoid cuts, scrapes and pinching. (D005)

#### (R001 part 1 of 2):



**DANGER:** Observe the following precautions when working on or around your IT rack system:

- · Heavy equipment-personal injury or equipment damage might result if mishandled.
- Always lower the leveling pads on the rack cabinet.
- Always install stabilizer brackets on the rack cabinet if provided, unless the earthquake option is to be installed..
- To avoid hazardous conditions due to uneven mechanical loading, always install the heaviest devices in the bottom of the rack cabinet. Always install servers and optional devices starting from the bottom of the rack cabinet.

• Rack-mounted devices are not to be used as shelves or work spaces. Do not place objects on top of rack-mounted devices. In addition, do not lean on rack mounted devices and do not use them to stabilize your body position (for example, when working from a ladder).



- · Stability hazard:
  - The rack may tip over causing serious personal injury.
  - Before extending the rack to the installation position, read the installation instructions.
  - Do not put any load on the slide-rail mounted equipment mounted in the installation position.
  - Do not leave the slide-rail mounted equipment in the installation position.
- Each rack cabinet might have more than one power cord.
  - For AC powered racks, be sure to disconnect all power cords in the rack cabinet when directed to disconnect power during servicing.
  - For racks with a DC power distribution panel (PDP), turn off the circuit breaker that controls the power to the system unit(s), or disconnect the customer's DC power source, when directed to disconnect power during servicing.
- Connect all devices installed in a rack cabinet to power devices installed in the same rack cabinet. Do not plug a power cord from a device installed in one rack cabinet into a power device installed in a different rack cabinet.
- An electrical outlet that is not correctly wired could place hazardous voltage on the metal parts
  of the system or the devices that attach to the system. It is the responsibility of the customer to
  ensure that the outlet is correctly wired and grounded to prevent an electrical shock. (R001 part
  1 of 2)

#### (R001 part 2 of 2):



#### **CAUTION:**

- Do not install a unit in a rack where the internal rack ambient temperatures will exceed the manufacturer's recommended ambient temperature for all your rack-mounted devices.
- Do not install a unit in a rack where the air flow is compromised. Ensure that air flow is not blocked or reduced on any side, front, or back of a unit used for air flow through the unit.
- Consideration should be given to the connection of the equipment to the supply circuit so that overloading of the circuits does not compromise the supply wiring or overcurrent protection. To provide the correct power connection to a rack, refer to the rating labels located on the equipment in the rack to determine the total power requirement of the supply circuit.
- (For sliding drawers.) Do not pull out or install any drawer or feature if the rack stabilizer brackets are not attached to the rack or if the rack is not bolted to the floor. Do not pull out more than one drawer at a time. The rack might become unstable if you pull out more than one drawer at a time.



• (For fixed drawers.) This drawer is a fixed drawer and must not be moved for servicing unless specified by the manufacturer. Attempting to move the drawer partially or completely out of the rack might cause the rack to become unstable or cause the drawer to fall out of the rack. (R001 part 2 of 2)



**CAUTION:** Removing components from the upper positions in the rack cabinet improves rack stability during relocation. Follow these general guidelines whenever you relocate a populated rack cabinet within a room or building.

- Reduce the weight of the rack cabinet by removing equipment starting at the top of the rack cabinet. When possible, restore the rack cabinet to the configuration of the rack cabinet as you received it. If this configuration is not known, you must observe the following precautions:
  - Remove all devices in the 32U position and above.
  - Ensure that the heaviest devices are installed in the bottom of the rack cabinet.
  - Ensure that there are little-to-no empty U-levels between devices installed in the rack cabinet below the 32U level, unless the received configuration specifically allowed it.
- If the rack cabinet you are relocating is part of a suite of rack cabinets, detach the rack cabinet from the suite.
- If the rack cabinet you are relocating was supplied with removable outriggers they must be reinstalled before the cabinet is relocated.
- Inspect the route that you plan to take to eliminate potential hazards.
- Verify that the route that you choose can support the weight of the loaded rack cabinet. Refer to the documentation that comes with your rack cabinet for the weight of a loaded rack cabinet.
- Verify that all door openings are at least 760 x 2083 mm (30 x 82 in.).
- Ensure that all devices, shelves, drawers, doors, and cables are secure.
- Ensure that the four leveling pads are raised to their highest position.
- Ensure that there is no stabilizer bracket installed on the rack cabinet during movement.
- Do not use a ramp inclined at more than 10 degrees.
- When the rack cabinet is in the new location, complete the following steps:
  - Lower the four leveling pads.
  - Install stabilizer brackets on the rack cabinet or in an earthquake environment bolt the rack to the floor.
  - If you removed any devices from the rack cabinet, repopulate the rack cabinet from the lowest position to the highest position.
- If a long-distance relocation is required, restore the rack cabinet to the configuration of the rack cabinet as you received it. Pack the rack cabinet in the original packaging material, or equivalent. Also lower the leveling pads to raise the casters off of the pallet and bolt the rack cabinet to the pallet.

(R002)

#### (L001)



**DANGER:** Hazardous voltage, current, or energy levels are present inside any component that has this label attached. Do not open any cover or barrier that contains this label. (L001)

(L002)

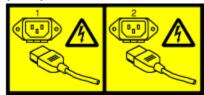




**DANGER:** Rack-mounted devices are not to be used as shelves or work spaces. Do not place objects on top of rack-mounted devices. In addition, do not lean on rack-mounted devices and do not use them to stabilize your body position (for example, when working from a ladder). Stability hazard:

- The rack may tip over causing serious personal injury.
- Before extending the rack to the installation position, read the installation instructions.
- Do not put any load on the slide-rail mounted equipment mounted in the installation position.
- Do not leave the slide-rail mounted equipment in the installation position. (L002)

#### (L003)



or



or



or

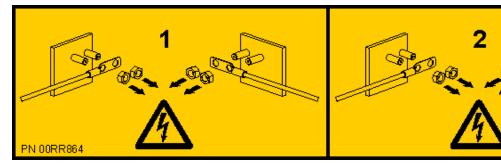


or









**DANGER:** Multiple power cords. The product might be equipped with multiple AC power cords or multiple DC power cables. To remove all hazardous voltages, disconnect all power cords and power cables. (L003)

(L007)



**CAUTION:** A hot surface nearby. (L007)

#### (L008)





**CAUTION:** Hazardous moving parts nearby. (L008)

All lasers are certified in the U.S. to conform to the requirements of DHHS 21 CFR Subchapter J for class 1 laser products. Outside the U.S., they are certified to be in compliance with IEC 60825 as a class 1 laser product. Consult the label on each part for laser certification numbers and approval information.



**CAUTION:** This product might contain one or more of the following devices: CD-ROM drive, DVD-ROM drive, DVD-RAM drive, or laser module, which are Class 1 laser products. Note the following information:

- Do not remove the covers. Removing the covers of the laser product could result in exposure to hazardous laser radiation. There are no serviceable parts inside the device.
- Use of the controls or adjustments or performance of procedures other than those specified herein might result in hazardous radiation exposure.

(C026)



**CAUTION:** Data processing environments can contain equipment transmitting on system links with laser modules that operate at greater than Class 1 power levels. For this reason, never look into the end of an optical fiber cable or open receptacle. Although shining light into one end and looking into the other end of a disconnected optical fiber to verify the continuity of optic fibers may not injure the eye, this procedure is potentially dangerous. Therefore, verifying the continuity of optical fibers by shining light into one end and looking at the other end is not recommended. To verify continuity of a fiber optic cable, use an optical light source and power meter. (C027)



**CAUTION:** This product contains a Class 1M laser. Do not view directly with optical instruments. (C028)



**CAUTION:** Some laser products contain an embedded Class 3A or Class 3B laser diode. Note the following information:

- · Laser radiation when open.
- Do not stare into the beam, do not view directly with optical instruments, and avoid direct exposure to the beam. (C030)

(C030)



**CAUTION:** The battery contains lithium. To avoid possible explosion, do not burn or charge the battery.

Do Not:

- · Throw or immerse into water
- Heat to more than 100 degrees C (212 degrees F)
- · Repair or disassemble

Exchange only with the IBM-approved part. Recycle or discard the battery as instructed by local regulations. In the United States, IBM has a process for the collection of this battery. For information, call 1-800-426-4333. Have the IBM part number for the battery unit available when you call. (C003)



**CAUTION:** Regarding IBM provided VENDOR LIFT TOOL:

· Operation of LIFT TOOL by authorized personnel only.

- LIFT TOOL intended for use to assist, lift, install, remove units (load) up into rack elevations. It is not to be used loaded transporting over major ramps nor as a replacement for such designated tools like pallet jacks, walkies, fork trucks and such related relocation practices. When this is not practicable, specially trained persons or services must be used (for instance, riggers or movers).
- Read and completely understand the contents of LIFT TOOL operator's manual before using.
   Failure to read, understand, obey safety rules, and follow instructions may result in property
   damage and/or personal injury. If there are questions, contact the vendor's service and support.
   Local paper manual must remain with machine in provided storage sleeve area. Latest revision
   manual available on vendor's web site.
- Test verify stabilizer brake function before each use. Do not over-force moving or rolling the LIFT TOOL with stabilizer brake engaged.
- Do not raise, lower or slide platform load shelf unless stabilizer (brake pedal jack) is fully engaged. Keep stabilizer brake engaged when not in use or motion.
- Do not move LIFT TOOL while platform is raised, except for minor positioning.
- Do not exceed rated load capacity. See LOAD CAPACITY CHART regarding maximum loads at center versus edge of extended platform.
- Only raise load if properly centered on platform. Do not place more than 200 lb (91 kg) on edge of sliding platform shelf also considering the load's center of mass/gravity (CoG).
- Do not corner load the platforms, tilt riser, angled unit install wedge or other such accessory options. Secure such platforms -- riser tilt, wedge, etc options to main lift shelf or forks in all four (4x or all other provisioned mounting) locations with provided hardware only, prior to use. Load objects are designed to slide on/off smooth platforms without appreciable force, so take care not to push or lean. Keep riser tilt [adjustable angling platform] option flat at all times except for final minor angle adjustment when needed.
- Do not stand under overhanging load.
- Do not use on uneven surface, incline or decline (major ramps).
- · Do not stack loads.
- Do not operate while under the influence of drugs or alcohol.
- Do not support ladder against LIFT TOOL (unless the specific allowance is provided for one following qualified procedures for working at elevations with this TOOL).
- Tipping hazard. Do not push or lean against load with raised platform.
- Do not use as a personnel lifting platform or step. No riders.
- Do not stand on any part of lift. Not a step.
- Do not climb on mast.
- Do not operate a damaged or malfunctioning LIFT TOOL machine.
- Crush and pinch point hazard below platform. Only lower load in areas clear of personnel and obstructions. Keep hands and feet clear during operation.
- No Forks. Never lift or move bare LIFT TOOL MACHINE with pallet truck, jack or fork lift.
- Mast extends higher than platform. Be aware of ceiling height, cable trays, sprinklers, lights, and other overhead objects.
- Do not leave LIFT TOOL machine unattended with an elevated load.
- Watch and keep hands, fingers, and clothing clear when equipment is in motion.
- Turn Winch with hand power only. If winch handle cannot be cranked easily with one hand, it is probably over-loaded. Do not continue to turn winch past top or bottom of platform travel. Excessive unwinding will detach handle and damage cable. Always hold handle when lowering, unwinding. Always assure self that winch is holding load before releasing winch handle.
- A winch accident could cause serious injury. Not for moving humans. Make certain clicking sound is heard as the equipment is being raised. Be sure winch is locked in position before releasing handle. Read instruction page before operating this winch. Never allow winch to unwind freely.

Freewheeling will cause uneven cable wrapping around winch drum, damage cable, and may cause serious injury.

• This TOOL must be maintained correctly for IBM Service personnel to use it. IBM shall inspect condition and verify maintenance history before operation. Personnel reserve the right not to use TOOL if inadequate. (C048)

#### Power and cabling information for NEBS (Network Equipment-Building System) GR-1089-CORE

The following comments apply to the IBM servers that have been designated as conforming to NEBS (Network Equipment-Building System) GR-1089-CORE:

The equipment is suitable for installation in the following:

- · Network telecommunications facilities
- Locations where the NEC (National Electrical Code) applies

The intrabuilding ports of this equipment are suitable for connection to intrabuilding or unexposed wiring or cabling only. The intrabuilding ports of this equipment *must not* be metallically connected to the interfaces that connect to the OSP (outside plant) or its wiring. These interfaces are designed for use as intrabuilding interfaces only (Type 2 or Type 4 ports as described in GR-1089-CORE) and require isolation from the exposed OSP cabling. The addition of primary protectors is not sufficient protection to connect these interfaces metallically to OSP wiring.

**Note:** All Ethernet cables must be shielded and grounded at both ends.

The ac-powered system does not require the use of an external surge protection device (SPD).

The dc-powered system employs an isolated DC return (DC-I) design. The DC battery return terminal *shall not* be connected to the chassis or frame ground.

The dc-powered system is intended to be installed in a common bonding network (CBN) as described in GR-1089-CORE.

## System processor modules

Find more information about removing and replacing a system processor module in the IBM Power System S914 (9009-41A and 9009-41G), IBM Power System S924 (9009-42A and 9009-42G), IBM Power System H924 (9223-42H), or IBM Power System H924S (9223-42S) server.

# Removing and replacing the system processor module in the 9009-41A, 9009-41G, 9009-42A, 9009-42G, 9223-42H, or 9223-42S

Find information about removing and replacing a system processor module in the 9009-41A, 9009-41G, 9009-42A, 9009-42G, 9223-42H, or 9223-42S system.

If your system is managed by the Hardware Management Console (HMC), use the HMC to repair a part in the system. For instructions, see Repairing a part by using the HMC (www.ibm.com/support/knowledgecenter/POWER9/p9haj/p9haj\_hmc\_repair.htm).

If you do not have an HMC, complete the steps in the following procedures to remove and replace a system processor module.

# Preparing the 9009-41A, 9009-41G, 9009-42A, 9009-42G, 9223-42H, or 9223-42S system to remove and replace the system processor module

To prepare the system to remove and replace the system processor module, complete the steps in this procedure.

#### Before you begin

As part of the system processor module replacement, the heat sink is removed. Before you begin the removal and replacement procedure, ensure that you have a spare TIM, part number 01ML035, and heat sink, part number 01ML180, on hand.

#### **Procedure**

- 1. Identify the part and the system that you are working on. For instructions, see <u>Identifying a part</u> (www.ibm.com/support/knowledgecenter/POWER9/p9haj/sal.htm).
  - Use the blue identify LED on the enclosure to locate the system. Ensure that the serial number of the system matches the serial number to be serviced.
- 2. Stop the system. For instructions, see <u>Stopping a system</u> (www.ibm.com/support/knowledgecenter/POWER9/p9haj/crustopsys.htm).
- 3. Label and disconnect the power cords from the system unit.
  - See Figure 1 on page 2 or Figure 2 on page 3.

#### Notes:

- This system might be equipped with two or more power supplies. If the removing and replacing procedures require the system power to be turned off, ensure that all the power sources to the system are disconnected.
- The power cord **(B)** is fastened to the system with hook-and-loop fastener **(A)**. If you are placing the system in a service position after you disconnect the power cords, ensure that you unstrap the fastener.

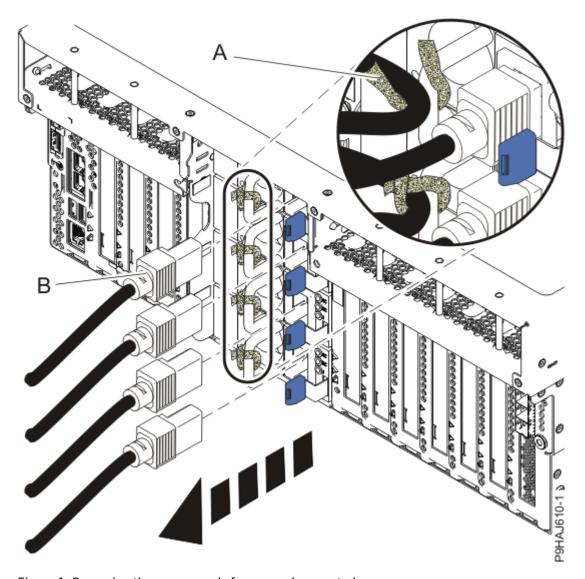


Figure 1. Removing the power cords from a rack-mounted server

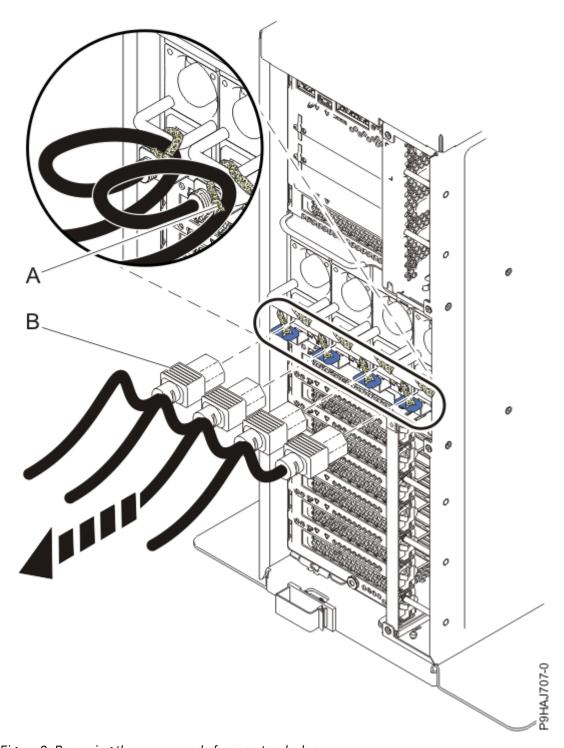


Figure 2. Removing the power cords from a stand-alone server

#### (L003)



or



or



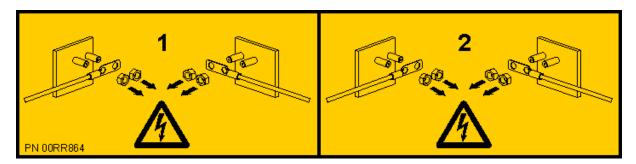
or



or









**DANGER:** Multiple power cords. The product might be equipped with multiple AC power cords or multiple DC power cables. To remove all hazardous voltages, disconnect all power cords and power cables. (L003)

- 4. Label and disconnect all external cables that are attached to the PCIe adapters.
- 5. For a rack-mounted system, open the side latches (A) and pull the latches to slide the system unit fully into the service position until the slides click and hold the system unit securely. Ensure that the screws inside the latches are not secured to the rack.

See the following figure.

Remove the hook-and-loop fasteners that secure the cable management arms. Ensure that the cable management arms can move freely. Ensure that the cables at the rear of the system do not catch or bind as you pull the system unit into the service position.

Do not pull out or install any drawer or feature if the rack stabilizer brackets are not attached to the rack. Do not pull out more than one drawer at a time. The rack might become unstable if you pull out more than one drawer at a time.



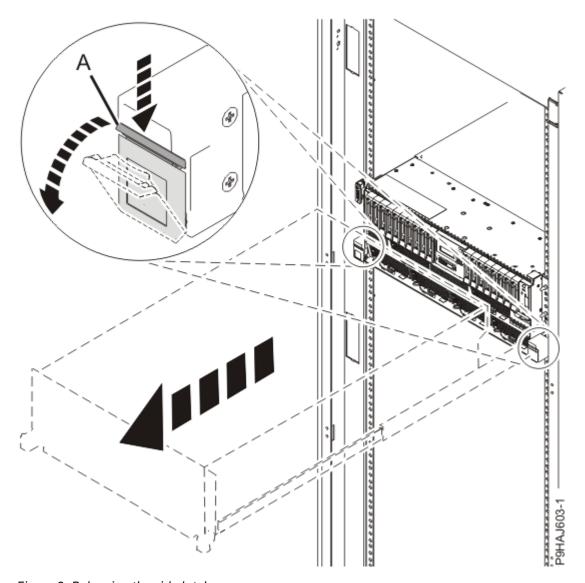


Figure 3. Releasing the side latches

6. Attach the electrostatic discharge (ESD) wrist strap.

The ESD wrist strap must be connected to an unpainted metal surface until the service procedure is completed, and if applicable, until the service access cover is replaced.



#### **Attention:**

- Attach an electrostatic discharge (ESD) wrist strap to the front ESD jack, to the rear ESD jack, or to an unpainted metal surface of your hardware to prevent the electrostatic discharge from damaging your hardware.
- When you use an ESD wrist strap, follow all electrical safety procedures. An ESD wrist strap is used for static control. It does not increase or decrease your risk of receiving electric shock when using or working on electrical equipment.
- If you do not have an ESD wrist strap, just prior to removing the product from ESD packaging and installing or replacing hardware, touch an unpainted metal surface of the system for a minimum of 5 seconds. If at any point in this service process you move away from the system, it is important to again discharge yourself by touching an unpainted metal surface for at least 5 seconds before you continue with the service process.
- 7. Remove the service access cover.

For a rack-mounted system, complete the following steps. Refer to Figure 4 on page 7.



Attention: Operating the system without the service access cover on for more than 10 minutes when the system power is turned on might damage the system components.

- a. Release the service cover latch by pushing the release latch (A) in the direction shown.
- b. Slide the cover (B) off the system unit. When the front of the service access cover clears the upper frame ledge, lift the cover up and off the system unit.

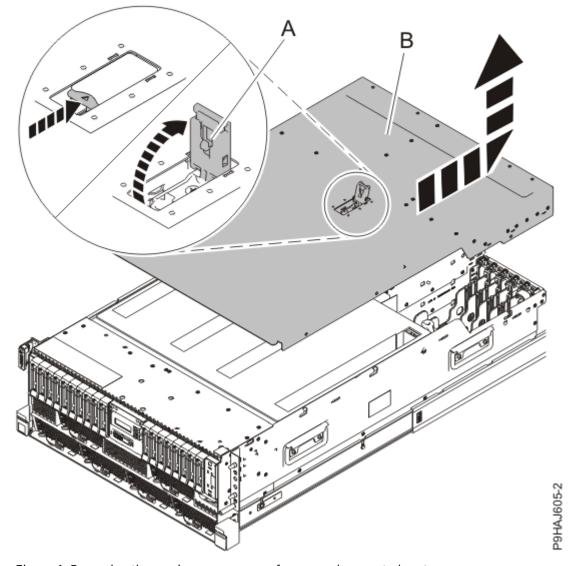


Figure 4. Removing the service access cover from a rack-mounted system

For a stand-alone system, complete the following steps. Refer to Figure 5 on page 8.



Attention: Operating the system without the service access cover on for more than 10 minutes when the system power is turned on might damage the system components.

- a. Release the latch by pushing the release latch (A) in the direction shown.
- b. Slide the cover (B) off the system unit. When the front of the service access cover has cleared the upper frame ledge, lift the cover up and off the system unit.

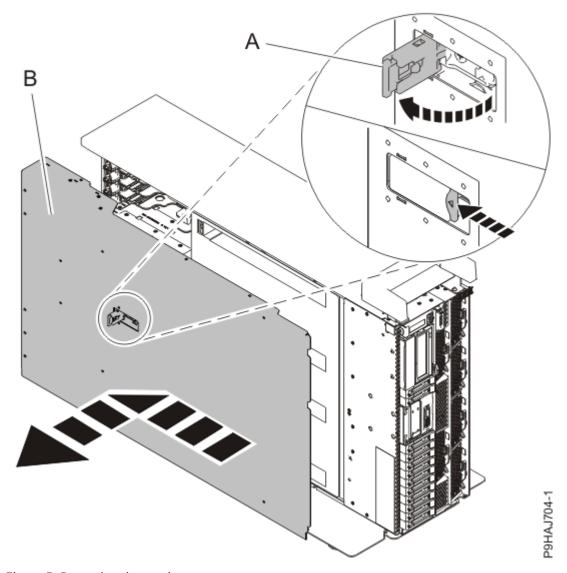


Figure 5. Removing the service access cover

- 8. Complete the following steps to place a stand-alone system into the service position:
  - a) Label and remove all cables that connect to the system.
  - b) Remove the power supplies from the system to lighten the system. Refer to Figure 6 on page 9.

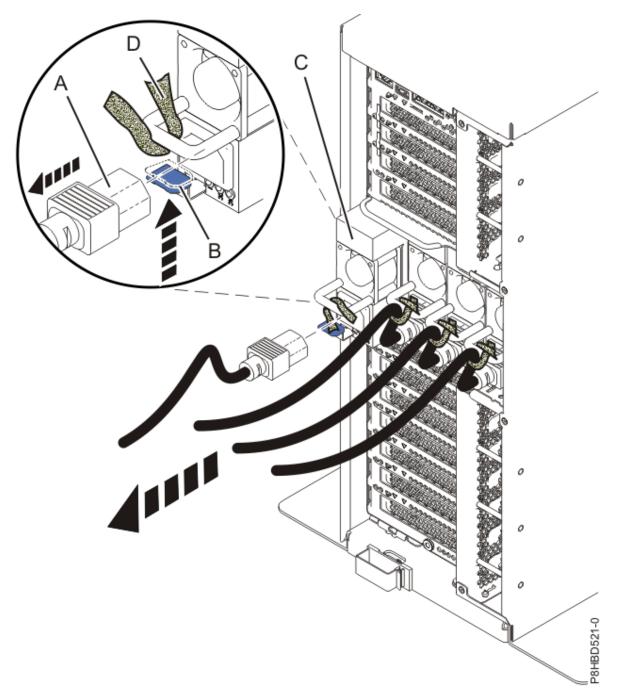


Figure 6. Removing the power supplies

- 1) Label the power cord, and then unstrap the hook-and-loop fastener (D) to release the power cord (A) from the power supply handle. Retain the hook-and-loop fastener for future use.
- 2) Pull the power cord (A) out of the power supply (C) in the direction shown. Pull the power cord connector; do not pull the cord itself.
- 3) To unseat the power supply from its position in the system, push the locking-tab (B) in the direction shown.
- 4) Using the handle **(E)**, pull the power supply **(C)** away from the system.
- 5) Repeat steps  $\underline{\text{"8.b.i"}}$  on page  $\underline{9}$   $\underline{\text{"8.b.iv"}}$  on page  $\underline{9}$  for each power supply.
- c) Remove the side cover.

Refer to Figure 7 on page 10.

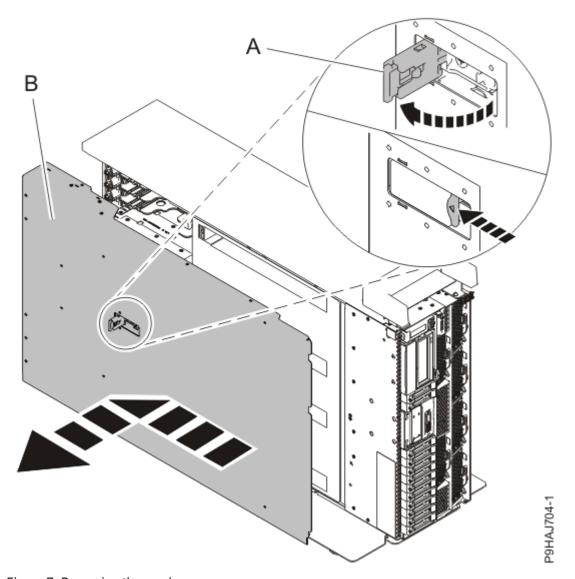


Figure 7. Removing the service access cover

- 1) Release the latch by pushing the release latch (A) in the direction shown.
- 2) Slide the cover **(B)** off the system unit. When the front of the service access cover has cleared the upper frame ledge, lift the cover up and off the system unit.
- d) Carefully tilt the stand-alone system from its vertical position to lay it in a horizontal position. Position the system with the open service area up, and with a 3 cm (1.5") support (A) along its top edge, as shown in Figure 8 on page 11.

The support (A) is used to prevent the plastic handle from being damaged.

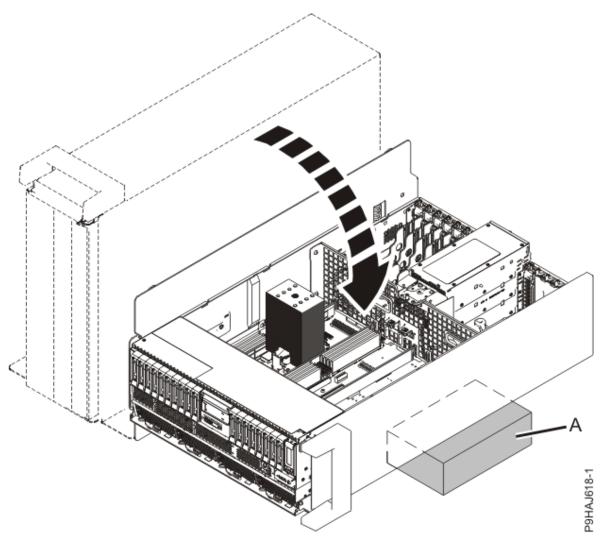


Figure 8. Tilting the stand-alone system to a horizontal position

9. Lift the air baffle **(A)** straight up as shown in Figure 9 on page 12.

Place the air baffle upside down on a clean area so that the foam does not collect contaminants.

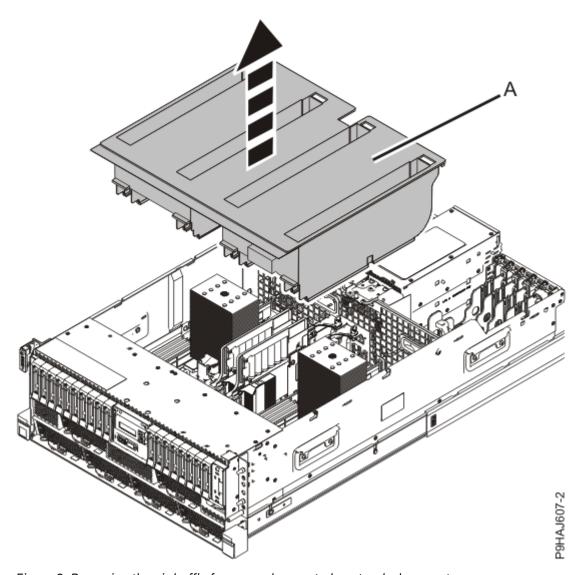


Figure 9. Removing the air baffle from a rack mounted or stand-alone system

- 10. Press and hold the push-button (A) on the trusted platform module card to activate the identify LED for the faulty part as shown in the following figure.
  - Verify that the LED (B) is lit, which indicates that sufficient power exists for the identify LED. If the LED (B) is not lit, use the location code to find the physical location by using the service label.

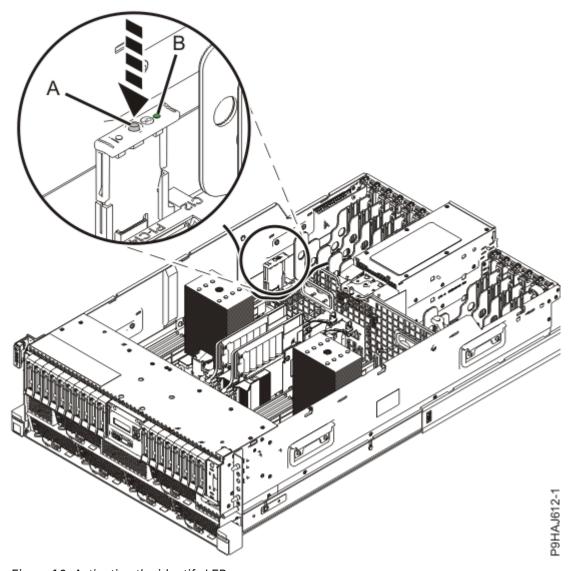


Figure 10. Activating the identify LED

#### Removing the system processor module from the 9009-41A, 9009-41G, 9009-42A, 9009-42G, 9223-42H, or 9223-42S system

To remove a system processor module, complete the steps in this procedure.

#### Before you begin

As part of the system processor module replacement, the heat sink is removed. Before you begin the removal and replacement procedure, ensure that you have a spare TIM, part number 01ML035, and heat sink, part number 01KL499, on hand.

#### **Procedure**

- 1. Ensure that you have the electrostatic discharge (ESD) wrist strap on and that the ESD clip is plugged into a ground jack or connected to an unpainted metal surface. If not, do so now.
- 2. Open the packaging of the new system processor module, and place the cover upside down next to the tray, as shown in Figure 11 on page 14. The cover is used for the system processor module that you are replacing.

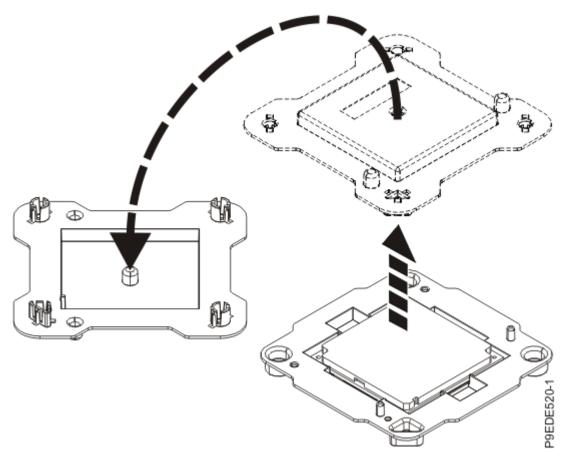


Figure 11. Opening the system processor module packaging

3. Remove the heat sink from the system processor module.

#### (L007)





**CAUTION:** A hot surface nearby. (L007)

- a. Loosen the heat sink actuation screw by turning the supplied hex key counterclockwise (A). Loosen the screw until it moves freely. See Figure 12 on page 15.
- b. Grip the heat sink **(B)** on opposing sides and remove the heat sink by lifting it upward. Set the heat sink aside with the module side facing upward.

**Note:** If you plan to remove dust or debris from the heat sink, this operation must be performed in another room that is greater than 7.6 m (24.9 ft) away from the work area.

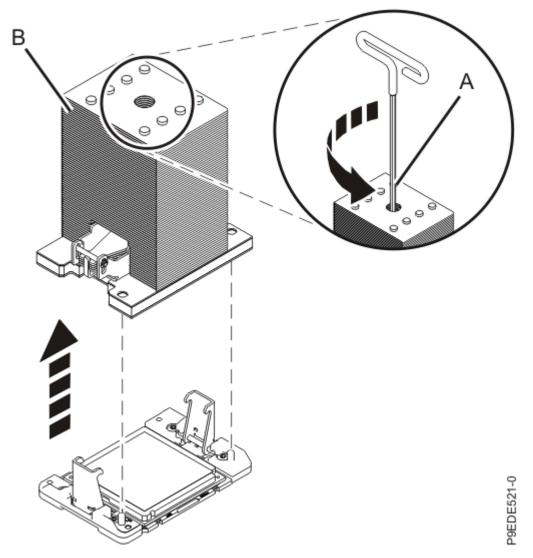


Figure 12. Removing the heat sink

4. Using the supplied tweezers, remove the TIM from the top of the system processor module and place it in a clean, dry area as shown in Figure 13 on page 16.

Be careful not to damage the TIM as it is very light and fragile.

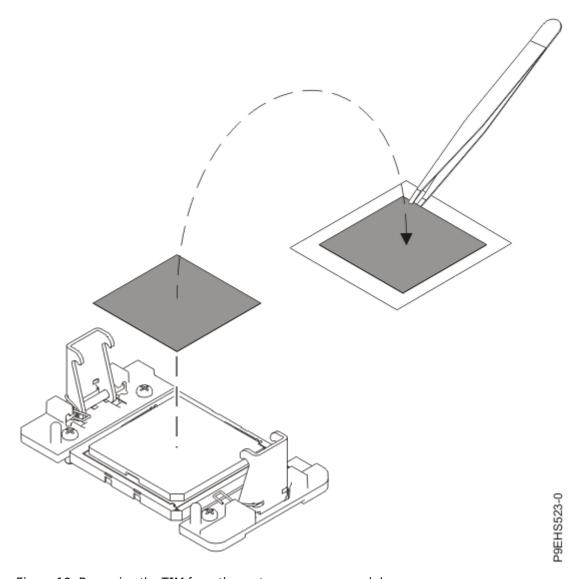


Figure 13. Removing the TIM from the system processor module

- 5. Prepare the system processor module for removal by completing the following steps.
  - a) Ensure that the removal tool **(A)** is in the open position as shown in <u>Figure 14 on page 17</u>. The middle ring **(B)** must be pushed down and blue tabs **(C)** must be turned inward.

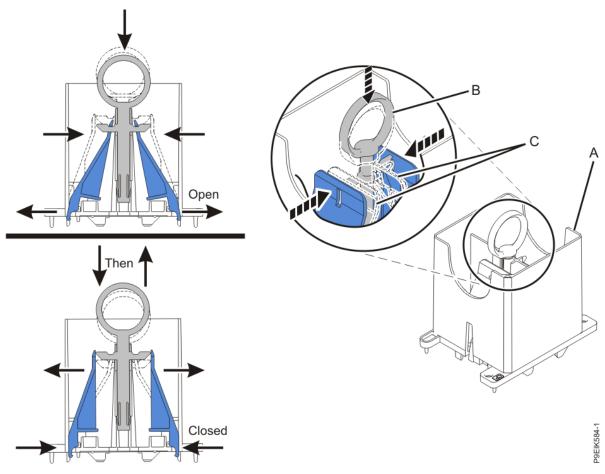


Figure 14. Ensuring that the removal tool is in the open position

- b) Align the tool over the system processor module. Ensure that the beveled edge on the tool aligns with the beveled edge of the system processor module (C) as shown in Figure 15 on page 18.
- c) Lower the tool over the system processor module. Ensure that the two guide pins (A) insert into the alignment holes (B) on each side of the tool as shown in Figure 15 on page 18.

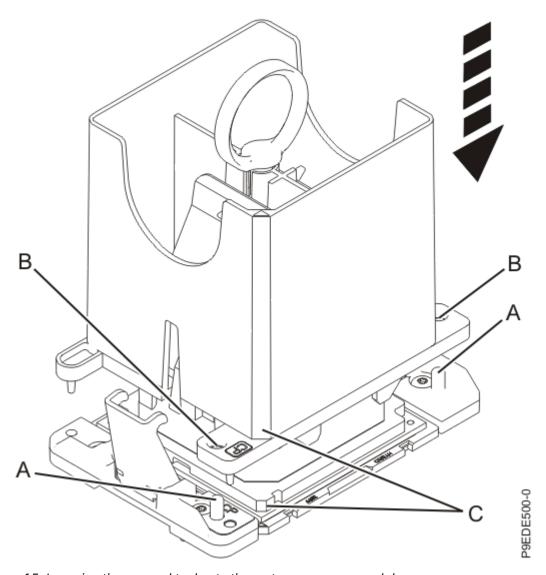


Figure 15. Lowering the removal tool onto the system processor module

d) With the removal tool sitting on top of the system processor module, push down on the ring (A) slightly so that the blue tabs (B) snap outward and the jaws engage with the system processor module as shown in Figure 16 on page 19.

Make sure that both of the tool jaws are locked onto the system processor module by pushing down on the tool.

**Important:** Do not press the blue release ring until directed to do so later.

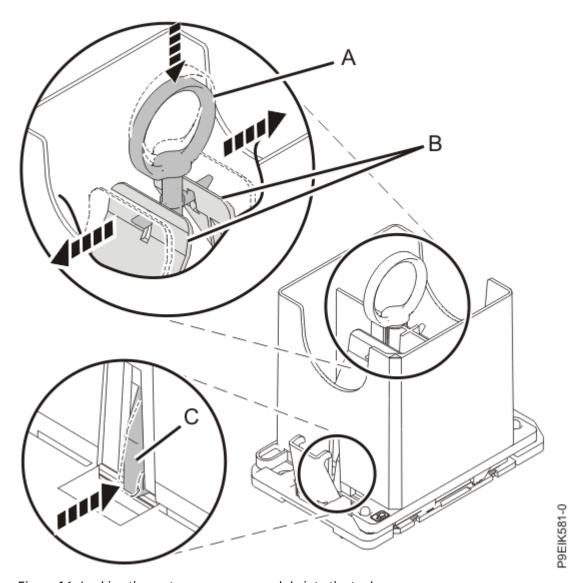
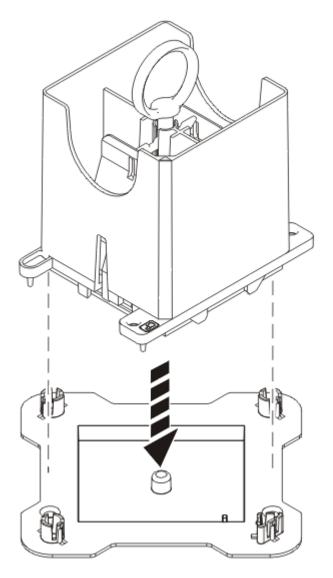


Figure 16. Locking the system processor module into the tool

6. Hold the outside of the tool and lift the tool and system processor module from the socket. Lift the tool upward slowly to ensure that the jaws are fully engaged with the system processor

module. Ensure that the system processor module does not disengage and fall back into the socket of the system processor module. If the system processor module falls back into the socket of system processor module, the pins may be damaged.

Place the system processor module at an angle on the top cover of the packaging as shown in Figure 17 on page 20. Setting the tool and system processor module at an angle on the top cover of the system processor module packaging makes it easier to place the system processor module in the packaging.



P9E1K588-0

Figure 17. Placing the tool at an angle on the top cover of the packaging

7. Release the system processor module by pushing the ring **(B)** downwards. Hold the ring **(B)** down while pushing the blue tabs **(C)** inwards as shown in <u>Figure 18 on page 21</u>. Ensure that the ring catches the openings on the blue tabs, and that the blue tabs are locked in a fixed position.

To prevent the system processor module from falling, pull up on the round lever before you place the tool on the top cover of the system processor module packaging.

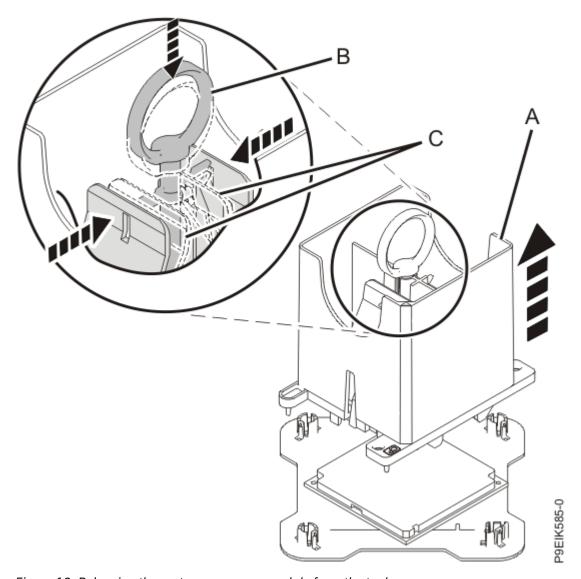


Figure 18. Releasing the system processor module from the tool

#### Replacing the system processor module in the 9009-41A, 9009-41G, 9009-42A, 9009-42G, 9223-42H, or 9223-42S system

To replace a system processor module in the system, complete the steps in this procedure.

#### **Procedure**

- 1. Ensure that you have the electrostatic discharge (ESD) wrist strap on and that the ESD clip is plugged into a ground jack or connected to an unpainted metal surface. If not, do so now.
- 2. Prepare the system processor module for installation:
  - a) Ensure that the removal tool is in the open position as shown in Figure 19 on page 22. The middle ring must be pushed down and blue tabs must be turned inward.

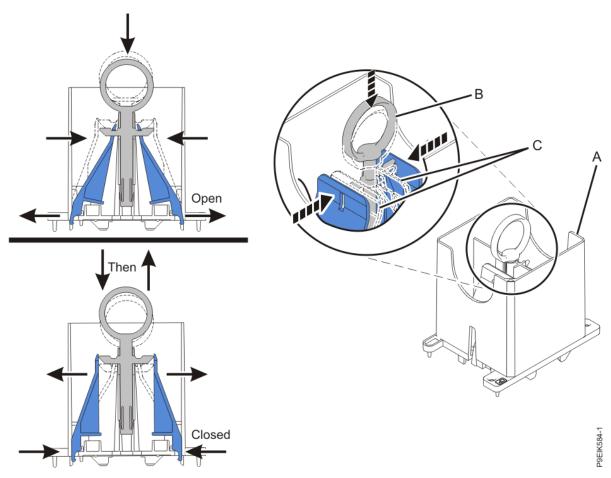


Figure 19. Ensuring that the removal tool is in the open position

b) Lower the tool over the system processor module as shown in Figure 20 on page 23. Ensure that the beveled edge on the tool aligns with the beveled edge of the system processor module. Ensure that the two guide pins (A) are inserted into the alignment holes (B) on each side of the tool.

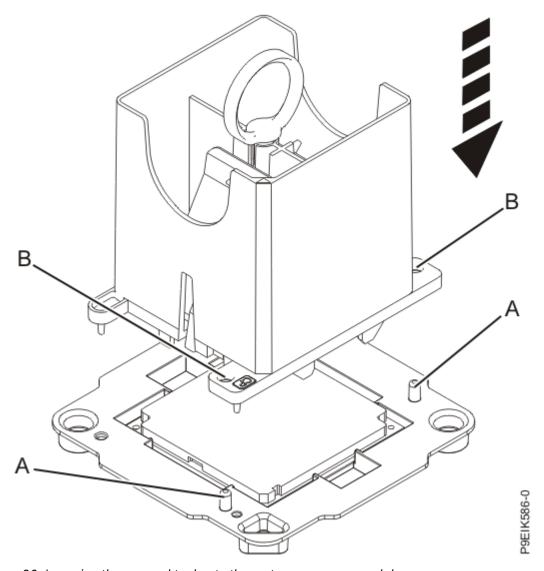


Figure 20. Lowering the removal tool onto the system processor module

c) With the removal tool sitting on top of the system processor module, push down on the ring (A) slightly so that the blue tabs (B) snap outward and the jaws engage with the system processor module (C) as shown in Figure 21 on page 24.

Make sure that both of the tool jaws are locked onto the system processor module by pushing down on the tool.

**Important:** Do not press the blue release tabs until directed to do so later.

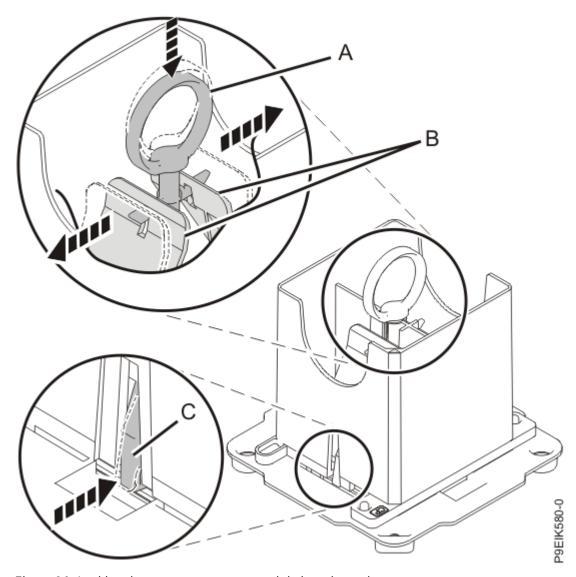


Figure 21. Locking the system processor module into the tool

- 3. Install the system processor module:
  - a) If dust or debris is present on the system processor socket, use the supplied air pump to clean the socket. Blow small bursts of air from the center toward the sides of the socket, as shown in Figure 22 on page 25.

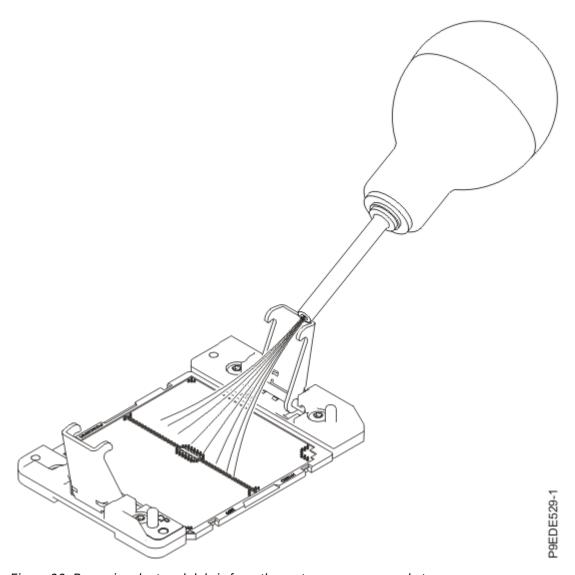


Figure 22. Removing dust and debris from the system processor socket

- b) Hold the sides of the tool with system processor module and carefully lift the tool out of the system processor module tray.
- c) Lower the tool and system processor module onto the socket. Align the beveled corner of the tool with the beveled corner on the socket. Align the guide pins (A) with the alignment holes (B) on each side of the tool. Use care to lower the tool evenly without tilting the tool. See Figure 23 on page 26.

Note: Do not attempt to slide the tool and the system processor module in any direction while the system processor module is touching the socket. If the tool and the system processor module are not aligned with the guide pins, lift the tool and the system processor module and reposition them.

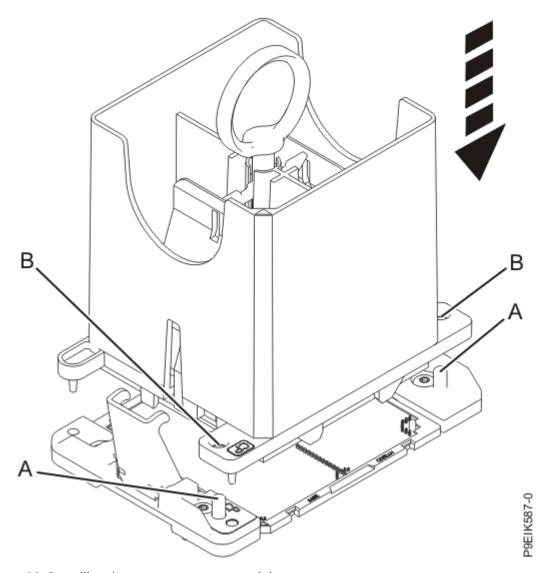


Figure 23. Installing the system processor module

d) Open the latches that hold the system processor module in the supplied removal tool **(A)** as shown in <u>Figure 24 on page 27</u>. Push down on the ring **(B)** while pressing in on the tabs **(C)**.

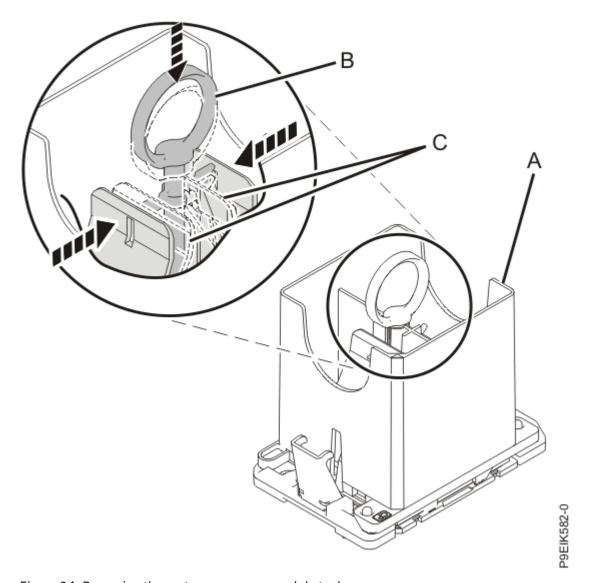


Figure 24. Removing the system processor module tool

- e) Lift the tool off the system processor module.
- 4. Inspect the thermal interface material (TIM) for visible signs of damage, as shown in Figure 25 on page 28.

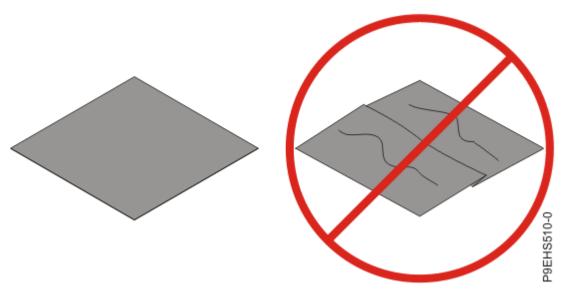


Figure 25. Inspecting the thermal interface material

5. Choose one of the following repair options:

Option	Description	
Is the TIM damaged?	It is damaged. continue to step <u>"6" on page 28</u> to replace the TIM and install the existing heat sink.	
Is the TIM not damaged?	It is not damaged and can be reused. continue to step <u>"7" on page 30</u> to move the TIM and install the existing heat sink.	

- 6. Use this step to install a new TIM and reuse the existing heat sink.
  - a) Open the TIM packaging and carefully remove the TIM, holding it by the edges of the carrier strip and holding it away from the shipping container.
  - b) Remove the protective film from the clear carrier strip by using the supplied tweezers.

**Note:** The TIM must remain flat. Small wrinkles are acceptable, but folds are not acceptable.

c) Using the tweezers, remove the TIM from the carrier strip and center it onto the system processor module.

The TIM has no preferred up side. The TIM can be placed on the system processor module and centered as shown in Figure 26 on page 29.

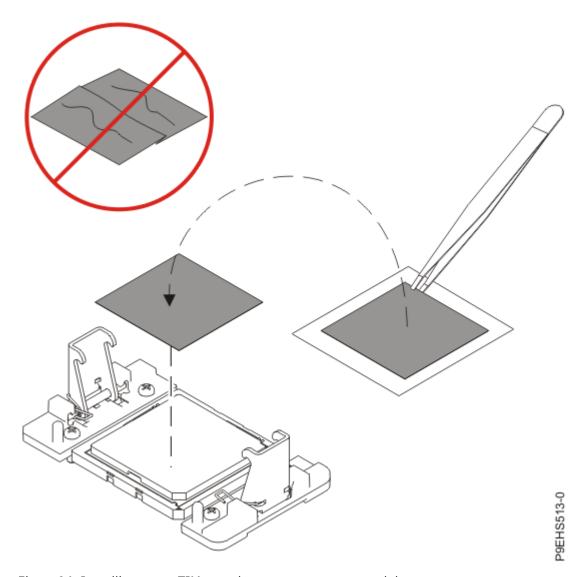


Figure 26. Installing a new TIM onto the system processor module d) Place the heat sink on the TIM as shown in  $\underline{\text{Figure 27 on page 30}}$ .

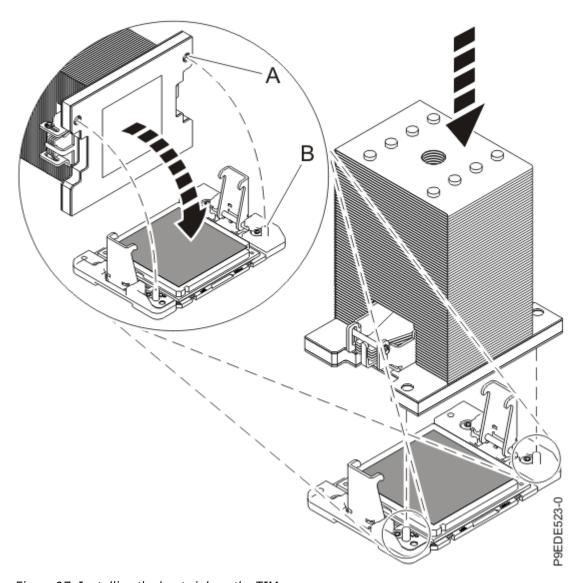


Figure 27. Installing the heat sink on the TIM

- 7. Use this step to reuse the existing undamaged TIM and heat sink.
  - a) Using the tweezers, move the old processor's TIM from the clean, dry surface and center it onto the new system processor module.
    - The TIM has no preferred up side. The TIM can be placed on the system processor module and centered as shown in Figure 28 on page 31.

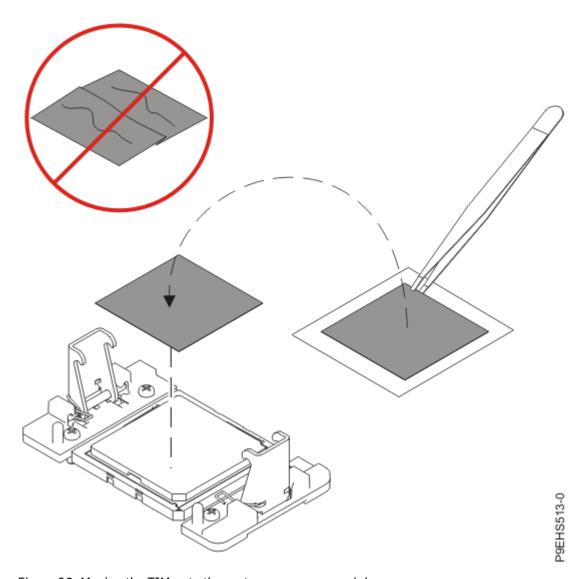


Figure 28. Moving the TIM onto the system processor module b) Place the heat sink on the TIM as shown in  $\underline{\text{Figure 29 on page 32}}.$ 

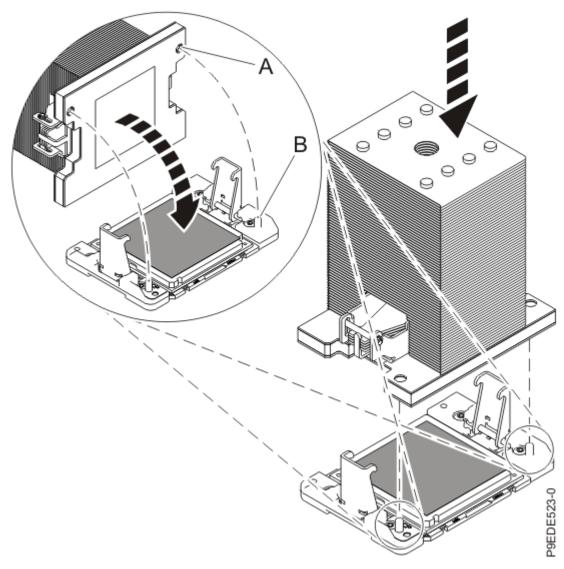


Figure 29. Installing the heat sink on the TIM

- 8. Secure the TIM and heat sink to the socket of the system processor module.
  - a) Ensure that the heat sink load arms are engaged as shown by (A) in Figure 30 on page 33.
  - b) Tighten the center load screw clockwise by using the supplied hex key as shown by **(B)** in Figure 30 on page 33 until a firm stop is reached. If the heat sink moves noticeably, the load arms are not engaged. Unscrew the center load screw and repeat this step again.

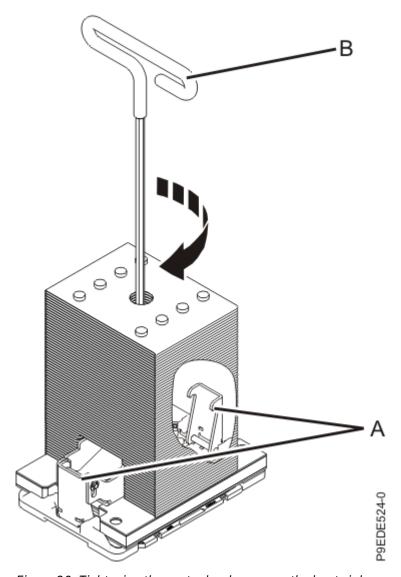


Figure 30. Tightening the center load screw on the heat sink

9. Lightly grip the system processor module that you replaced by the edges and lift it off of the packaging cover. Align the beveled corner of the module (A) to the corner of the packaging with triangle (B) and place it in the packaging, as shown in Figure 31 on page 34. Close the packaging cover.

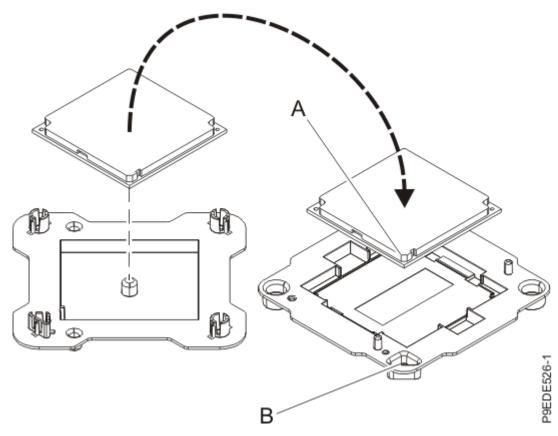


Figure 31. Placing the system processor module into the packaging

# Preparing the 9009-41A, 9009-41G, 9009-42A, 9009-42G, 9223-42H, or 9223-42S system for operation after removing or replacing a system processor module

To prepare the system for operation after removing or replacing a system processor module, complete the steps in this procedure.

#### **Procedure**

- 1. Ensure that you have the electrostatic discharge (ESD) wrist strap on and that the ESD clip is plugged into a ground jack or connected to an unpainted metal surface. If not, do so now.
- 2. Replace the air baffle **(A)** straight down into the chassis as shown in <u>Figure 32 on page 35</u>. Ensure that the front flap tucks under the front chassis.

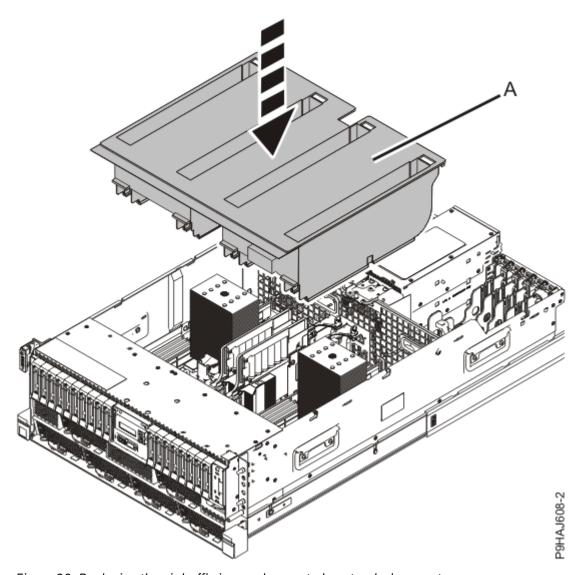


Figure 32. Replacing the air baffle in a rack mounted or stand-alone system

- 3. Complete the following steps to place a stand-alone system into the operating position:
  - a) Carefully tilt the stand-alone system from its horizontal position back to its vertical position. See Figure 33 on page 36.

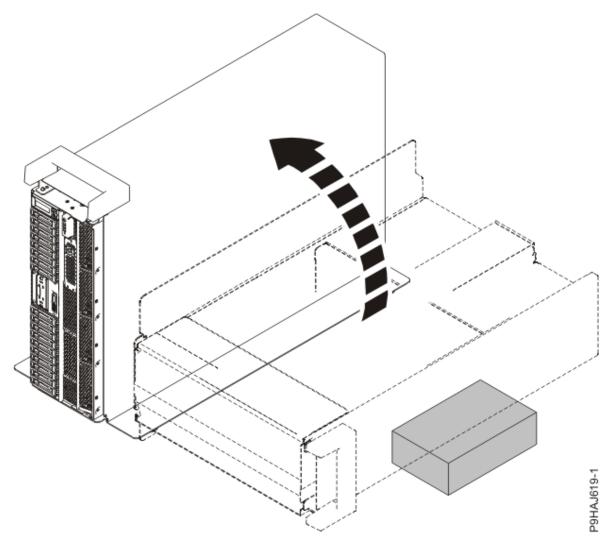


Figure 33. Moving the stand-alone system to the vertical position

b) Replace the side cover.

Refer to Figure 34 on page 37.

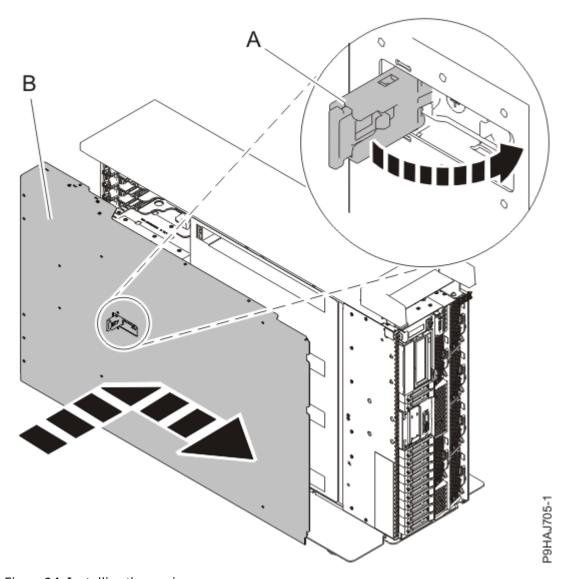


Figure 34. Installing the service access cover

- 1) Slide the cover **(B)** on to the system unit as shown.
- 2) Close the latch release (A) by pushing it in the direction shown.
- c) Replace the power supplies into the system. Refer to Figure 35 on page 38.

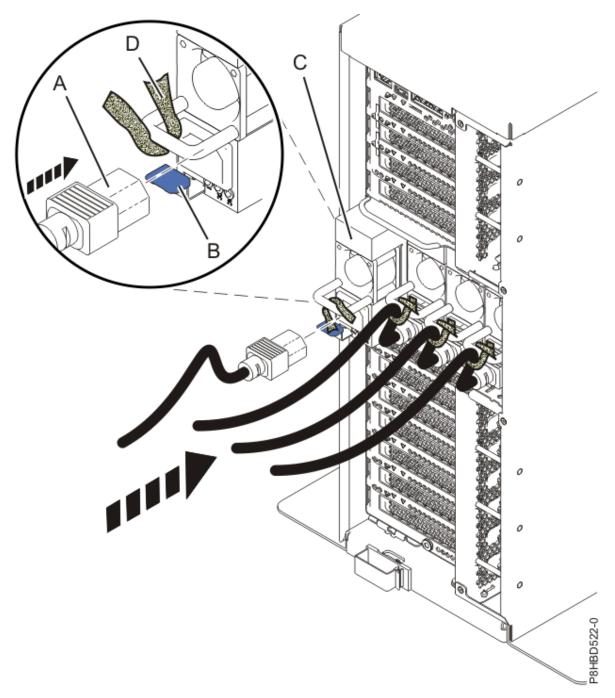


Figure 35. Replacing a power supply

- 1) Align the power supply **(C)** with the bay and slide the power supply into the system until the latch **(B)** locks in place.
- 2) Connect the power cord (A) to the power supply (C).
- 3) Use the hook-and-loop fastener **(D)** and tie the power cord to the power supply handle.
- d) Using your labels, replace the cables that connected to the system.
- 4. Replace the service access cover.

For a rack-mounted system, complete the following steps. Refer to Figure 36 on page 39.

- a. Slide the cover (A) onto the system unit.
- b. Close the release latch (B) by pushing it in the direction shown.

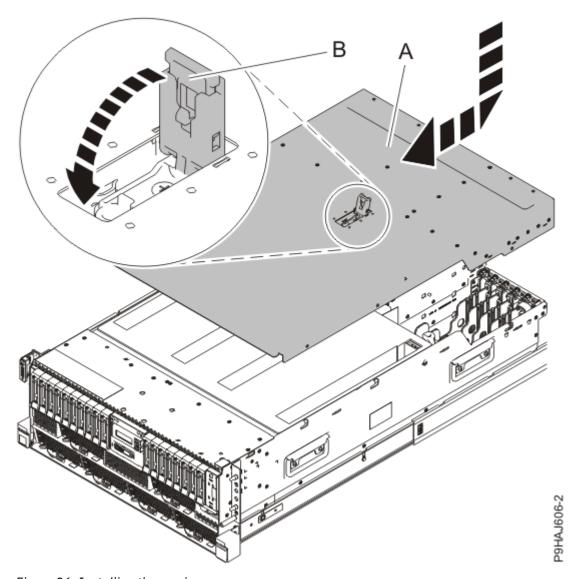


Figure 36. Installing the service access cover

For a stand-alone system, complete the following steps. Refer to Figure 37 on page 40.

- a. Slide the cover **(B)** on to the system unit as shown.
- b. Close the latch release (A) by pushing it in the direction shown.

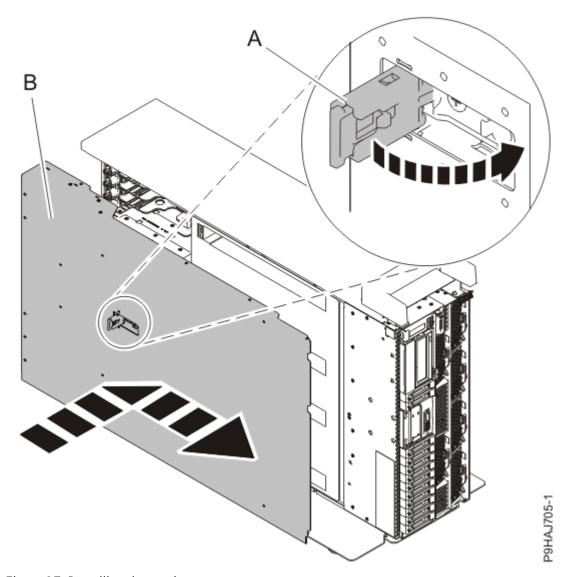


Figure 37. Installing the service access cover

- 5. For a rack-mounted system, unlock the blue rail safety latches **(A)** as shown in <u>Figure 38 on page 41</u> by pushing them inward.
  - Ensure that the cable management arms can move freely. Ensure that the cables at the rear of the unit do not catch or bind as you push the unit into the operating position.

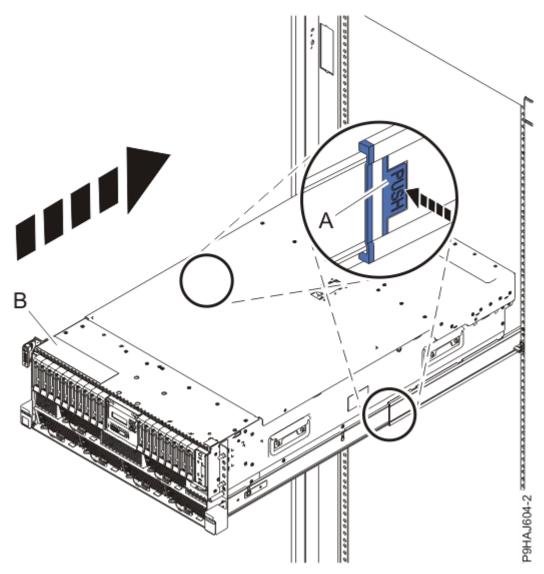


Figure 38. Placing the system into the operating position

- 6. For a rack-mounted system, push the system unit (B) as shown in the previous figure back into the rack until both release latches lock the system into position.
  - Secure the cable management arm with hook-and-loop fasteners around the back side of the cable management arm, but not around the cables.
- 7. Using your labels, reconnect the power cords (A) to the system unit.
  - Fasten the power cords (A) to the system using the hook-and-loop fasteners (B) as shown in Figure 39 on page 42 or Figure 40 on page 43.

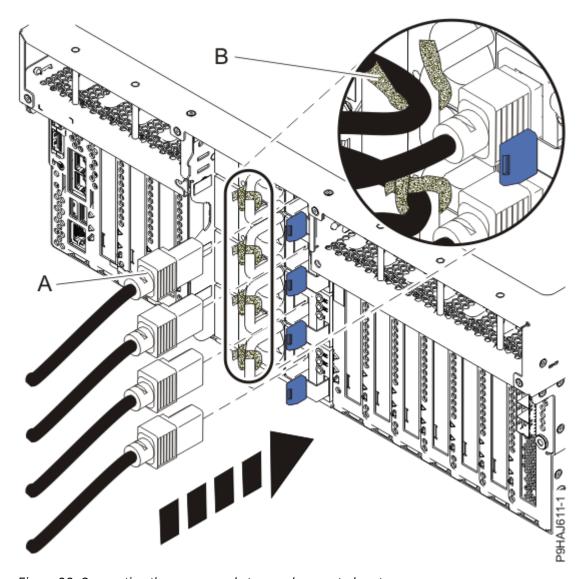


Figure 39. Connecting the power cords to a rack-mounted system

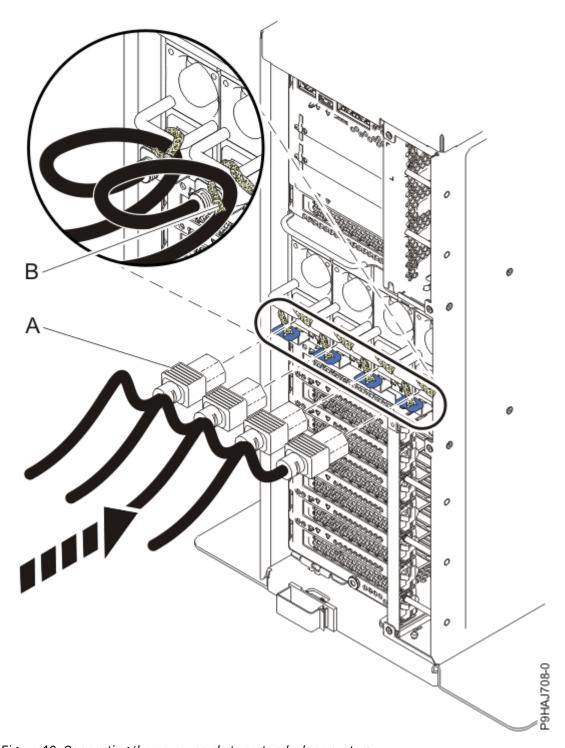


Figure 40. Connecting the power cords to a stand-alone system

- 8. Start the system. For instructions, see Starting a system (www.ibm.com/support/knowledgecenter/ POWER9/p9haj/crustartsys.htm).
- 9. Turn off the identify LED. For instructions, see Deactivating an identify LED (www.ibm.com/support/ knowledgecenter/POWER9/p9haj/p9haj\_turn\_off\_identify\_led.htm).
- 10. Verify the installed part.
  - If you replaced the part because of a service action, verify the installed part. For instructions, see Verifying a repair (www.ibm.com/support/knowledgecenter/POWER9/p9ect/ pxect\_verifyrepair.htm).
  - If you installed the part for any other reason, verify the installed part. For instructions, see Verifying the installed part (www.ibm.com/support/knowledgecenter/POWER9/p9haj/pxhaj\_hsmverify.htm).

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"Warnung: Dieses ist eine Einrichtung der Klasse A. Diese Einrichtung kann im Wohnbereich Funk-Störungen verursachen; in diesem Fall kann vom Betreiber verlangt werden, angemessene Maßnahmen zu ergreifen und dafür aufzukommen."

#### Deutschland: Einhaltung des Gesetzes über die elektromagnetische Verträglichkeit von Geräten

Dieses Produkt entspricht dem "Gesetz über die elektromagnetische Verträglichkeit von Geräten (EMVG) ". Dies ist die Umsetzung der EU-Richtlinie 2014/30/EU in der Bundesrepublik Deutschland.

## Zulassungsbescheinigung laut dem Deutschen Gesetz über die elektromagnetische Verträglichkeit von Geräten (EMVG) (bzw. der EMC Richtlinie 2014/30/EU) für Geräte der Klasse A

Dieses Gerät ist berechtigt, in Übereinstimmung mit dem Deutschen EMVG das EG-Konformitätszeichen - CE - zu führen.

Verantwortlich für die Einhaltung der EMV Vorschriften ist der Hersteller: International Business Machines Corp.

New Orchard Road Armonk, New York 10504

Tel: 914-499-1900

Der verantwortliche Ansprechpartner des Herstellers in der EU ist: IBM Deutschland GmbH

Technical Relations Europe, Abteilung M456 IBM-Allee 1, 71139 Ehningen, Germany

Tel: +49 (0) 800 225 5426 email: HalloIBM@de.ibm.com

Generelle Informationen:

Das Gerät erfüllt die Schutzanforderungen nach EN 55024 und EN 55022 / EN 55032 Klasse A.

#### Japan Electronics and Information Technology Industries Association (JEITA) Notice

(一社) 電子情報技術産業協会 高調波電流抑制対策実施 要領に基づく定格入力電力値: Knowledge Centerの各製品の 仕様ページ参照

This statement applies to products less than or equal to 20 A per phase.

高調波電流規格 JIS C 61000-3-2 適合品

This statement applies to products greater than 20 A, single phase.

高調波電流規格 JIS C 61000-3-2 準用品

本装置は、「高圧又は特別高圧で受電する需要家の高調波抑制対策ガイドライン」対象機器(高調波発生機器)です。

回路分類 : 6 (単相、PFC回路付)

換算係数 : 0

This statement applies to products greater than 20 A per phase, three-phase.

高調波電流規格 JIS C 61000-3-2 準用品

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回路分類 : 5 (3相、PFC回路付)

換算係数 : 0

#### Japan Voluntary Control Council for Interference (VCCI) Notice

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#### **Korea Notice**

이 기기는 업무용 환경에서 사용할 목적으로 적합성평가를 받은 기기로서 가정용 환경에서 사용하는 경우 전파간섭의 우려가 있습니다.

#### People's Republic of China Notice

声 鸱

此为 A 级产品,在生活环境中,该产品可能会造成无线电干扰, 在这种情况下,可能需要用户对其 干扰采取切实可行的措施。

#### **Russia Notice**

ВНИМАНИЕ! Настоящее изделие относится к классу А. В жилых помещениях оно может создавать радиопомехи, для снижения которых необходимы дополнительные меры

#### **Taiwan Notice**

警告使用者:

此為甲類資訊技術設備, 於居住環境中使用時,可 能會造成射頻擾動,在此 種情況下,使用者會被要 求採取某些適當的對策。

#### **IBM Taiwan Contact Information:**

台灣IBM 產品服務聯絡方式: 台灣國際商業機器股份有限公司

台北市松仁路7號3樓

電話:0800-016-888

#### **United States Federal Communications Commission (FCC) Notice**

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference, in which case the user will be required to correct the interference at his own expense.

Properly shielded and grounded cables and connectors must be used in order to meet FCC emission limits. Proper cables and connectors are available from IBM-authorized dealers. IBM is not responsible for any radio or television interference caused by using other than recommended cables and connectors or by unauthorized changes or modifications to this equipment. Unauthorized changes or modifications could void the user's authority to operate the equipment.

This device complies with Part 15 of the FCC rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Responsible Party:
International Business Machines Corporation
New Orchard Road
Armonk, NY 10504
Contact for FCC compliance information only: fccinfo@us.ibm.com

#### **Class B Notices**

The following Class B statements apply to features designated as electromagnetic compatibility (EMC) Class B in the feature installation information.

When attaching a monitor to the equipment, you must use the designated monitor cable and any interference suppression devices supplied with the monitor.

#### **Canada Notice**

CAN ICES-3 (B)/NMB-3(B)

#### **European Community and Morocco Notice**

This product is in conformity with the protection requirements of Directive 2014/30/EU of the European Parliament and of the Council on the harmonization of the laws of the Member States relating to electromagnetic compatibility. IBM cannot accept responsibility for any failure to satisfy the protection requirements resulting from a non-recommended modification of the product, including the fitting of non-IBM option cards.

#### **German Notice**

## Deutschsprachiger EU Hinweis: Hinweis für Geräte der Klasse B EU-Richtlinie zur Elektromagnetischen Verträglichkeit

Dieses Produkt entspricht den Schutzanforderungen der EU-Richtlinie 2014/30/EU zur Angleichung der Rechtsvorschriften über die elektromagnetische Verträglichkeit in den EU-Mitgliedsstaatenund hält die Grenzwerte der EN 55022/EN 55032 Klasse B ein.

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#### Deutschland: Einhaltung des Gesetzes über die elektromagnetische Verträglichkeit von Geräten

Dieses Produkt entspricht dem "Gesetz über die elektromagnetische Verträglichkeit von Geräten (EMVG) ". Dies ist die Umsetzung der EU-Richtlinie 2014/30/EU in der Bundesrepublik Deutschland.

### Zulassungsbescheinigung laut dem Deutschen Gesetz über die elektromagnetische Verträglichkeit von Geräten (EMVG) (bzw. der EMC Richtlinie 2014/30/EU) für Geräte der Klasse B

Dieses Gerät ist berechtigt, in Übereinstimmung mit dem Deutschen EMVG das EG-Konformitätszeichen - CE - zu führen.

Verantwortlich für die Einhaltung der EMV Vorschriften ist der Hersteller: International Business Machines Corp. New Orchard Road Armonk, New York 10504

Tel: 914-499-1900

Der verantwortliche Ansprechpartner des Herstellers in der EU ist: IBM Deutschland GmbH Technical Relations Europe, Abteilung M456 IBM-Allee 1, 71139 Ehningen, Germany Tel: +49 (0) 800 225 5426 email: HalloIBM@de.ibm.com

Generelle Informationen:

#### Das Gerät erfüllt die Schutzanforderungen nach EN 55024 und EN 55032 Klasse B

#### Japan Electronics and Information Technology Industries Association (JEITA) Notice

(一社) 電子情報技術産業協会 高調波電流抑制対策実施 要領に基づく定格入力電力値: Knowledge Centerの各製品の 仕様ページ参照

This statement applies to products less than or equal to 20 A per phase.

高調波電流規格 JIS C 61000-3-2 適合品

This statement applies to products greater than 20 A, single phase.

高調波電流規格 JIS C 61000-3-2 準用品

本装置は、「高圧又は特別高圧で受電する需要家の高調波抑制対策ガイドライン」対象機器(高調波発生機器)です。

回路分類 : 6 (単相、PFC回路付)

換算係数 : 0

This statement applies to products greater than 20 A per phase, three-phase.

#### 高調波電流規格 JIS C 61000-3-2 準用品

本装置は、「高圧又は特別高圧で受電する需要家の高調波抑制対策ガイドライン」対象機器(高調波発生機器)です。

回路分類 : 5 (3相、PFC回路付)

換算係数 : 0

#### Japan Voluntary Control Council for Interference (VCCI) Notice

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VCCI-B

#### **Taiwan Notice**

台灣IBM 產品服務聯絡方式: 台灣國際商業機器股份有限公司 台北市松仁路7號3樓

電話:0800-016-888

#### **United States Federal Communications Commission (FCC) Notice**

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- · Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult an IBM-authorized dealer or service representative for help.

Properly shielded and grounded cables and connectors must be used in order to meet FCC emission limits. Proper cables and connectors are available from IBM-authorized dealers. IBM is not responsible for any radio or television interference caused by using other than recommended cables and connectors or by unauthorized changes or modifications to this equipment. Unauthorized changes or modifications could void the user's authority to operate the equipment.

This device complies with Part 15 of the FCC rules. Operation is subject to the following two conditions:

(1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Responsible Party:

International Business Machines Corporation
New Orchard Road
Armonk, New York 10504
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